

Features

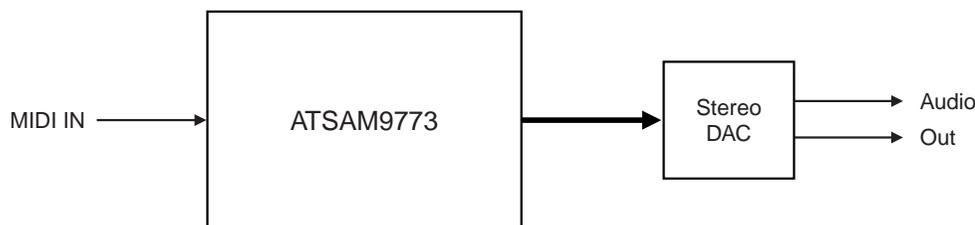
- Synthesizer, Reverb, Chorus on a Single Chip
- No External ROM or RAM
- Single-chip, All-in-one design Only Requires External DAC
 - MIDI Control Processor
 - Synthesis, General MIDI Wavetable Implementation
 - Compatible Effects: Reverb + Chorus
 - Programmable Spatial Effects or Four-channel Surround ⁽¹⁾
 - 3DMIDI™ Four-speaker MIDI ⁽¹⁾
 - 4-band Stereo Equalizer
- State-of-the-art Synthesis for Best Quality/Price Products
 - 38-voice Polyphony + Effects
 - On-chip Wavetable Data, Firmware, RAM Delay Lines
- Synthesizer Chipset: ATSAM9773 + DAC
- Hardware-programmable DAC Mode
 - I²S 16 to 20 bits
 - Japanese 16 bits
- Typical Applications: Cost-sensitive PC Wavetable Synthesis/Portable Karaoke/VCD Karaoke
- 80-lead TQFP Package: Small Footprint, Easy Mounting
- Ideal for Battery Operation
 - Low Power
 - Power-down Mode
 - Wide Supply Voltage Range : 2.45V to 2.95V Core, 3V to 5.5V Periphery

Note: 1. Four-channel surround and 3DMIDI™ require additional DAC.

Description

The ATSAM9773 provides a single-chip, low-cost MIDI sound system. Equipped with a serial MIDI input, it provides state-of-the-art sound synthesis together with a range of compatible effects. Its low power consumption makes it ideal for battery-powered applications such as portable Karaoke or VCD Karaoke systems. It can also be used for cost-sensitive PC-based wavetable synthesis applications.

Figure 1. Typical Hardware Configuration



Sound Synthesis

ATSAM9773 Single-chip Synthesizer with Effects, Serial Interface



Pin Description

Pins by Function

Table 1. Power Supply Group

Pin Name	Pin Number	Type	Function
GND	5, 14, 21, 23, 30, 38, 57, 59, 61, 65, 74	PWR	Digital Ground All pins should be connected to a ground plane.
VCC	6, 13, 18, 22, 32, 56, 64, 80	PWR	Power Supply, 3V to 5.5V All pins should be connected to a VCC plane.
VC3	1, 7, 17, 60, 63	PWR	Core Power Supply, 2.45V to 2.95V All pins should be connected to nominal 2.7V.

Table 2. Serial MIDI

Pin Name	Pin Number	Type	Function
MIDI IN	15	IN	Serial TTL MIDI IN. All controls are received by this pin.

Table 3. Digital Audio Group

Pin Name	Pin Number	Type	Function
CLBD	19	OUT	Digital audio bit clock
WSBD	27	OUT	Digital audio left/right select
DABD0	25	OUT	Digital audio main stereo output
DABD1	26	OUT	Auxiliary digital stereo output. Surround or 3DMIDI output.
DACSEL	24	IN	DAC type: 0 = I ² S 16 to 20 bits, 1 = Japanese 16 bits

Table 4. Miscellaneous Group

Pin Name	Pin Number	Type	Function
X1 - X2	10, 9	–	9.6 MHz crystal connection. An external 9.6 MHz clock can also be used on X1 (2.7V input). X2 cannot be used to drive external circuits, use CKOUT instead.
CKOUT	20	OUT	Buffered X2 output. Can be used to drive external DAC master clock (256 x Fs).
LFT	8	–	PLL external RC network
$\overline{\text{RESET}}$	11	IN	Reset input, active low. This is a Schmidt trigger input, allowing direct connection of an RC network
$\overline{\text{PDWN}}$	12	IN	Power down, active low. When power down is active, then all output pins will be floated. The crystal oscillator will be stopped. To exit from power down, $\overline{\text{PDWN}}$ should be high and $\overline{\text{RESET}}$ applied.
TEST0 - TEST4	33, 34, 35, 36, 62	IN	Test pins. Should be grounded.
RUN	16	OUT	When high, indicates that the synthesizer is up and running.

Note: Pin names exhibiting an overbar ($\overline{\text{PDWN}}$ for example) indicate that the signal is active low.

Pinout by Pin Number

Table 5. Pinout by Pin Number ⁽¹⁾

Pin Number	Pin Name	Pin Number	Pin Name	Pin Number	Pin Name	Pin Number	Pin Name
1	VC3	21	GND	41	NC	61	GND
2	NC	22	VCC	42	NC	62	TEST4
3	NC	23	GND	43	NC	63	VC3
4	NC	24	DACSEL	44	NC	64	VCC
5	GND	25	DABD0	45	NC	65	GND
6	VCC	26	DABD1	46	NC	66	NC
7	VC3	27	WSBD	47	NC	67	NC
8	LFT	28	NC	48	NC	68	NC
9	X2	29	NC	49	NC	69	NC
10	X1	30	GND	50	NC	70	NC
11	$\overline{\text{RESET}}$	31	NC	51	NC	71	NC
12	$\overline{\text{PDWN}}$	32	VCC	52	NC	72	NC
13	VCC	33	TEST0	53	NC	73	NC
14	GND	34	TEST1	54	NC	74	GND
15	MIDI IN	35	TEST2	55	NC	75	NC
16	RUN	36	TEST3	56	VCC	76	NC
17	VC3	37	NC	57	GND	77	NC
18	VCC	38	GND	58	NC	78	NC
19	CLBD	39	NC	59	GND	79	NC
20	CKOUT	40	NC	60	VC3	80	VCC

Note: 1. Signals marked NC should be left unconnected.



Absolute Maximum Ratings

Table 6. Absolute Maximum Ratings

Ambient Temperature (Power applied)	-40°C to + 85°C	<p>*NOTICE: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.</p>
Storage Temperature.....	-65°C to + 150°C	
Voltage on any pin (except X1).....	-0.5V to $V_{CC} + 0.5V$	
Voltage on X1 pin.....	$V_{C3} + 0.5V$	
V_{CC} Supply Voltage.....	-0.5V to + 6.5V	
V_{C3} Supply Voltage.....	-0.5V to + 4.5V	
Maximum I_{OL} per I/O pin	10mA	

Recommended Operating Conditions

Table 7. Recommended Operating Conditions

Symbol	Parameter/Condition	Min	Typ	Max	Unit
V_{CC}	Supply Voltage ⁽¹⁾	3	3.3/5.0	5.5	V
V_{C3}	Supply Voltage	2.45	2.7	2.95	V
T_A	Operating Ambient Temperature	0	–	70	°C

Note: 1. When using 3.3V supply in a 5V environment, care must be taken that pin voltage does not exceed $V_{CC} + 0.5V$. Pin X1 is powered by V_{C3} input. If X1 is driven by a 5V device, then a minimum series resistor is required (typ 330Ω).

DC Characteristics

Table 8. DC Characteristics ($T_A = 25^\circ\text{C}$, $V_{C3} = 2.7V \pm 10\%$)

Symbol	Parameter/Condition	VCC	Min	Typ	Max	Unit
V_{IL}	Low-level Input Voltage	3.3	-0.5		1.0	V
		5.0	-0.5		1.7	V
V_{IH}	High-level Input Voltage	3.3	2.3		$V_{CC} + 0.5$	V
		5.0	3.3		$V_{CC} + 0.5$	V
V_{OL}	Low-level Output Voltage ($I_{OL} = -3.2\text{ mA}$)	3.3			0.45	V
		5.0			0.45	V
V_{OH}	High-level Output Voltage ($I_{OH} = 0.8\text{ mA}$)	3.3	2.8			V
		5.0	4.5			V
I_{CC}	Power Supply Current (crystal freq. = 9.6 MHz)	3.3		50	70	mA
		5.0		10	15	mA
	Power Down Supply Current			70	100	μA

Digital Audio

Figure 2. Digital Audio Timing

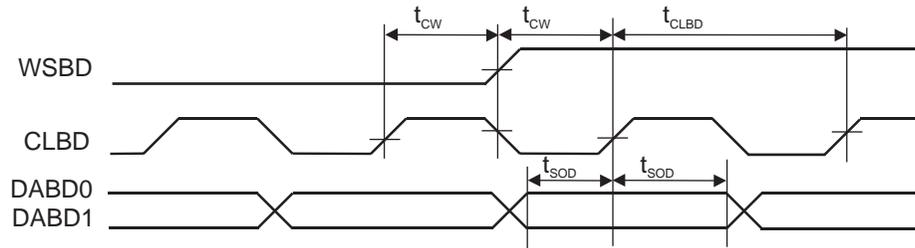
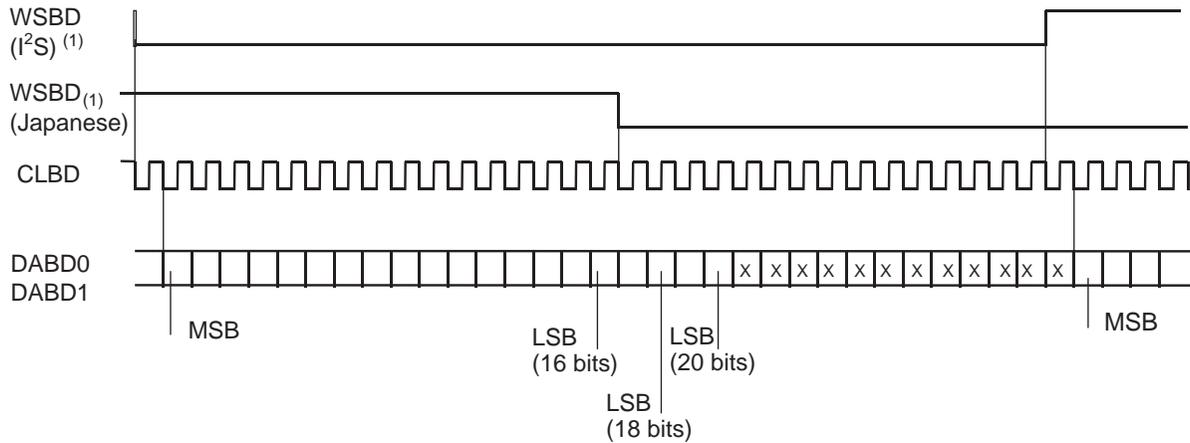


Table 9. Timing Parameters

Symbol	Parameter	Min	Typ	Max	Unit
t_{cw}	CLBD Rising to WSBD Change	200			ns
t_{sod}	DABDx Valid Prior to/after CLBD Rising	200			ns
t_{clbd}	CLBD Cycle Time		416.67		ns

Digital Audio Frame

Figure 3. Digital Audio Frame Format ⁽¹⁾



Note: 1. Selection between I²S and Japanese format is made through DACSEL pin .



Reset and Power-down

During power-up, the $\overline{\text{RESET}}$ input should be held low until the crystal oscillator and PLL are stabilized, which can take about 20 ms. A typical RC/diode power-up network can be used.

After $\overline{\text{RESET}}$, the ATSAM9773 enters an initialization routine. It will take around 50 ms before a MIDI IN message can be processed.

If $\overline{\text{PDWN}}$ is asserted low, then all I/Os and outputs will be floated, the crystal oscillator and PLL will be stopped. The chip enters a deep power-down sleep mode. To exit power down, $\overline{\text{PDWN}}$ has to be asserted high, then $\overline{\text{RESET}}$ applied.

Recommended Board Layout

As for all HCMOS high-integration ICs, some rules of board layout should be followed for reliable operation:

- GND, V_{CC} , V_{C3} distribution, decouplings

All GND, V_{CC} , V_{C3} pins should be connected. GND + V_{CC} planes are strongly recommended below the ATSAM9773. The board GND + V_{CC} distribution should be in grid form. For 5V operation, if 2.7V is not available, then V_{C3} can be connected to V_{CC} by three 1N4148 diodes in series.

Recommended V_{CC} decoupling is 0.1 μF at each corner of the IC with an additional 10 μT decoupling close to the crystal. V_{C3} requires a single 0.1 μF decoupling close to the IC.

- Crystal, LFT

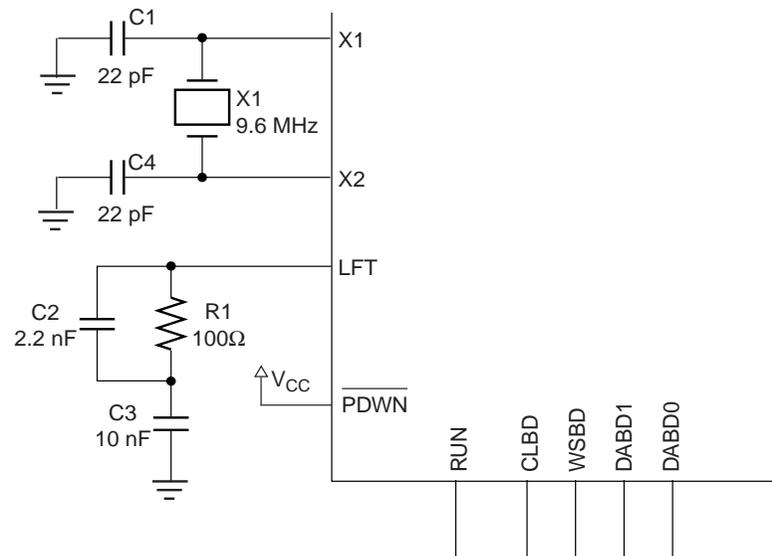
The paths between the crystal, the crystal compensation capacitors, the LFT filter R-C-R and the ATSAM9773 should be short and shielded. The ground return from the compensation capacitors and LFT filter should be the GND plane from ATSAM9773.

- Analog Section

A specific AGND ground plane should be provided, which connects by a single trace to the GND ground. No digital signals should cross the AGND plane. Refer to the Codec vendor recommended layout for correct implementation of the analog section.

Recommended Crystal Compensation and LFT Filter

Figure 4. Recommended Crystal Compensation and LFT Filter



Mechanical Dimensions

Figure 5. 80-lead Thin Plastic Quad Flat Pack

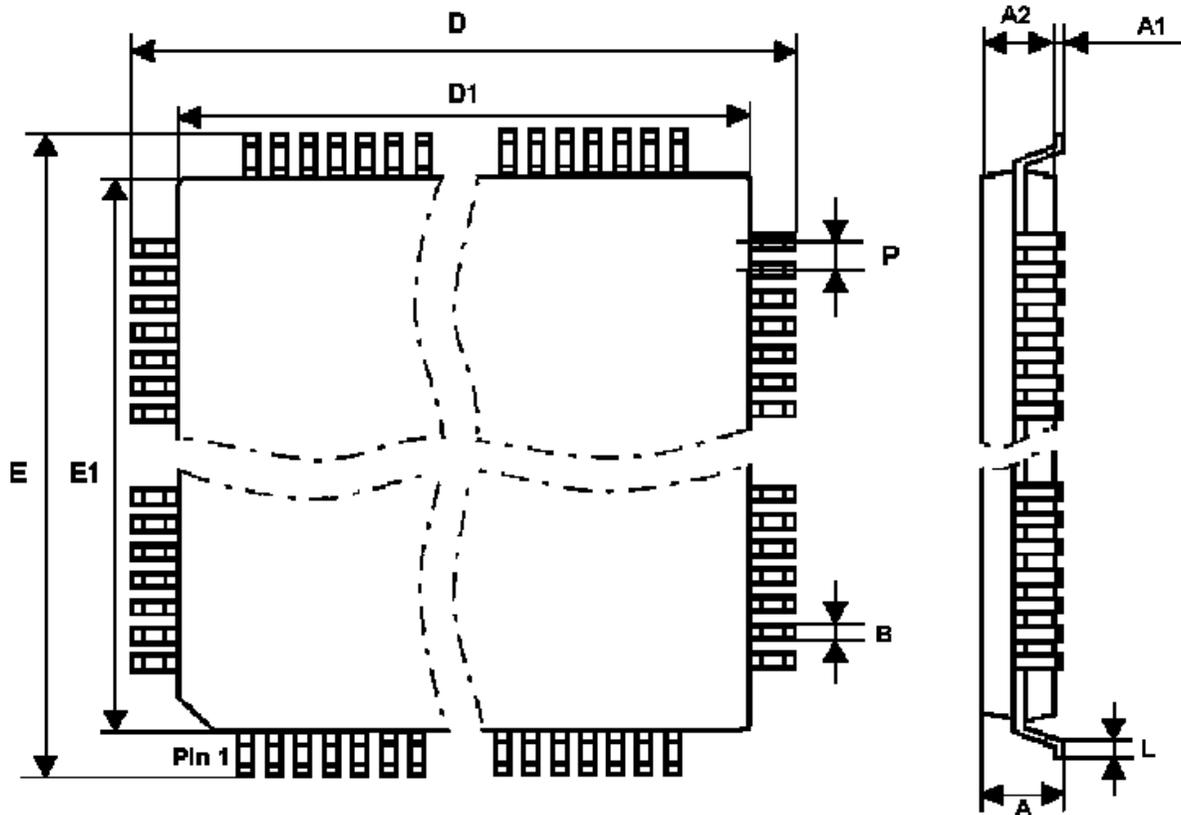


Table 10. Package Dimensions (in millimeters)

Dimension	Min	Typ	Max
A	1.40	1.50	1.60
A1	0.05	0.10	0.15
A2	1.35	1.40	1.45
D	15.90	16.00	16.10
D1	13.90	14.00	14.10
E	15.90	16.00	16.10
E1	13.90	14.00	14.10
L	0.45	0.60	0.75
P		0.65	
B	0.22	0.32	0.38



Atmel Headquarters

Corporate Headquarters

2325 Orchard Parkway
San Jose, CA 95131
TEL 1(408) 441-0311
FAX 1(408) 487-2600

Europe

Atmel Sarl
Route des Arsenaux 41
Case Postale 80
CH-1705 Fribourg
Switzerland
TEL (41) 26-426-5555
FAX (41) 26-426-5500

Asia

Room 1219
Chinachem Golden Plaza
77 Mody Road Tsimhatsui
East Kowloon
Hong Kong
TEL (852) 2721-9778
FAX (852) 2722-1369

Japan

9F, Tonetsu Shinkawa Bldg.
1-24-8 Shinkawa
Chuo-ku, Tokyo 104-0033
Japan
TEL (81) 3-3523-3551
FAX (81) 3-3523-7581

Atmel Operations

Memory

2325 Orchard Parkway
San Jose, CA 95131
TEL 1(408) 441-0311
FAX 1(408) 436-4314

Microcontrollers

2325 Orchard Parkway
San Jose, CA 95131
TEL 1(408) 441-0311
FAX 1(408) 436-4314

La Chantrerie
BP 70602
44306 Nantes Cedex 3, France
TEL (33) 2-40-18-18-18
FAX (33) 2-40-18-19-60

ASIC/ASSP/Smart Cards

Zone Industrielle
13106 Rousset Cedex, France
TEL (33) 4-42-53-60-00
FAX (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd.
Colorado Springs, CO 80906
TEL 1(719) 576-3300
FAX 1(719) 540-1759

Scottish Enterprise Technology Park
Maxwell Building
East Kilbride G75 0QR, Scotland
TEL (44) 1355-803-000
FAX (44) 1355-242-743

RF/Automotive

Theresienstrasse 2
Postfach 3535
74025 Heilbronn, Germany
TEL (49) 71-31-67-0
FAX (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd.
Colorado Springs, CO 80906
TEL 1(719) 576-3300
FAX 1(719) 540-1759

Biometrics/Imaging/Hi-Rel MPU/ High Speed Converters/RF Datacom

Avenue de Rochepleine
BP 123
38521 Saint-Egreve Cedex, France
TEL (33) 4-76-58-30-00
FAX (33) 4-76-58-34-80

e-mail

literature@atmel.com

Web Site

<http://www.atmel.com>

© Atmel Corporation 2002.

Atmel Corporation makes no warranty for the use of its products, other than those expressly contained in the Company's standard warranty which is detailed in Atmel's Terms and Conditions located on the Company's web site. The Company assumes no responsibility for any errors which may appear in this document, reserves the right to change devices or specifications detailed herein at any time without notice, and does not make any commitment to update the information contained herein. No licenses to patents or other intellectual property of Atmel are granted by the Company in connection with the sale of Atmel products, expressly or by implication. Atmel's products are not authorized for use as critical components in life support devices or systems.

ATMEL® is the registered trademark of Atmel; 3DMIDI™ is the trademark of Atmel.

Other terms and product names may be the trademark of others.



Printed on recycled paper.